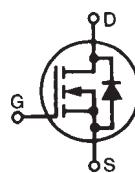
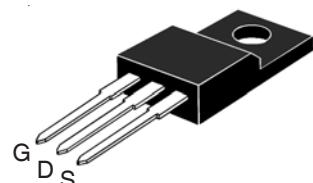


**Polar3™ HiperFET™
Power MOSFET**
IXFP20N50P3M

N-Channel Enhancement Mode
Avalanche Rated
Fast Intrinsic Rectifier



V_{DSS} = 500V
I_{D25} = 8A
R_{DS(on)} ≤ 300mΩ

OVERMOLDED


G = Gate D = Drain
S = Source

Symbol	Test Conditions	Maximum Ratings		
V _{DSS}	T _J = 25°C to 150°C	500	V	
V _{DGR}	T _J = 25°C to 150°C, R _{GS} = 1MΩ	500	V	
V _{GSS}	Continuous	± 30	V	
V _{GSM}	Transient	± 40	V	
I _{D25}	T _C = 25°C	8	A	
I _{DM}	T _C = 25°C, Pulse Width Limited by T _{JM}	40	A	
I _A	T _C = 25°C	10	A	
E _{AS}	T _C = 25°C	300	mJ	
dv/dt	I _S ≤ I _{DM} , V _{DD} ≤ V _{DSS} , T _J ≤ 150°C	35	V/ns	
P _D	T _C = 25°C	58	W	
T _J		-55 ... +150	°C	
T _{JM}		150	°C	
T _{stg}		-55 ... +150	°C	
T _L	Maximum Lead Temperature for Soldering	300	°C	
T _{SOLD}	Plastic Body for 10s	260	°C	
M _d	Mounting Torque	1.13 / 10	Nm/lb.in	
Weight		2.5	g	

Symbol	Test Conditions (T _J = 25°C Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
BV _{DSS}	V _{GS} = 0V, I _D = 1mA	500		V
V _{GS(th)}	V _{DS} = V _{GS} , I _D = 1.5mA	3.0		V
I _{GSS}	V _{GS} = ±30V, V _{DS} = 0V			±100 nA
I _{DSS}	V _{DS} = V _{DSS} , V _{GS} = 0V T _J = 125°C			25 μA 1.25 mA
R _{DS(on)}	V _{GS} = 10V, I _D = 10A, Note 1			300 mΩ

Features

- Plastic Overmolded Tab for Electrical Isolation
- Fast Intrinsic Rectifier
- Avalanche Rated
- Low R_{DS(ON)} and Q_G
- Low Package Inductance

Advantages

- High Power Density
- Easy to Mount
- Space Savings

Applications

- Switch-Mode and Resonant-Mode Power Supplies
- DC-DC Converters
- Laser Drivers
- AC and DC Motor Drives
- Robotics and Servo Controls

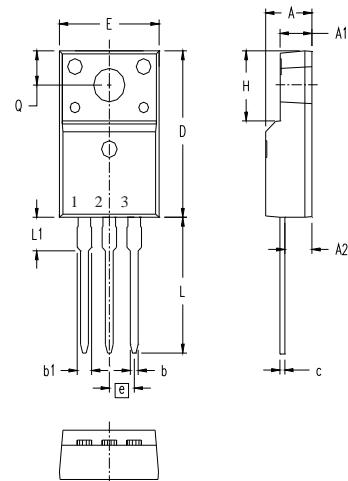
Symbol	Test Conditions (T _J = 25°C Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
g_{fs}	V _{DS} = 20V, I _D = 10A, Note 1	11	18	S
C_{iss} C_{oss} C_{rss}	V _{GS} = 0V, V _{DS} = 25V, f = 1MHz	1800		pF
		230		pF
		8.3		pF
R_{GI}	Gate Input Resistance	2.3		Ω
t_{d(on)} t_r t_{d(off)} t_f	Resistive Switching Times V _{GS} = 10V, V _{DS} = 0.5 • V _{DSS} , I _D = 10A R _G = 5Ω (External)	10		ns
		5		ns
		43		ns
		9		ns
Q_{g(on)} Q_{gs} Q_{gd}	V _{GS} = 10V, V _{DS} = 0.5 • V _{DSS} , I _D = 10A	36		nC
		7		nC
		13		nC
R_{thJC}			2.15	°C/W

Source-Drain Diode

Symbol	Test Conditions (T _J = 25°C Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
I_s	V _{GS} = 0V		20	A
I_{SM}	Repetitive, Pulse Width Limited by T _{JM}		80	A
V_{SD}	I _F = I _S , V _{GS} = 0V, Note 1		1.4	V
t_{rr} I_{RM} Q_{RM}	I _F = 10A, -di/dt = 100A/μs V _R = 100V, V _{GS} = 0V		250	ns
			8.0	A
			0.6	μC

Note 1. Pulse test, t ≤ 300μs, duty cycle, d ≤ 2%.

ISOLATED TO-220 (IXFP...M)



Terminals:
1 - Gate
2 - Drain
3 - Source

SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.177	.193	4.50	4.90
A1	.092	.108	2.34	2.74
A2	.101	.117	2.56	2.96
b	.028	.035	0.70	0.90
b1	.050	.058	1.27	1.47
c	.018	.024	0.45	0.60
D	.617	.633	15.67	16.07
E	.392	.408	9.96	10.36
e	.100	BSC	2.54	BSC
H	.255	.271	6.48	6.88
L	.499	.523	12.68	13.28
L1	.119	.135	3.03	3.43
ØP	.121	.129	3.08	3.28
Q	.126	.134	3.20	3.40

PRELIMINARY TECHNICAL INFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from a subjective evaluation of the design, based upon prior knowledge and experience, and constitute a "considered reflection" of the anticipated result. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.

IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents:

4,835,592	4,931,844	5,049,961	5,237,481	6,162,665	6,404,065 B1	6,683,344	6,727,585	7,005,734 B2	7,157,338B2
4,860,072	5,017,508	5,063,307	5,381,025	6,259,123 B1	6,534,343	6,710,405 B2	6,759,692	7,063,975 B2	
4,881,106	5,034,796	5,187,117	5,486,715	6,306,728 B1	6,583,505	6,710,463	6,771,478 B2	7,071,537	

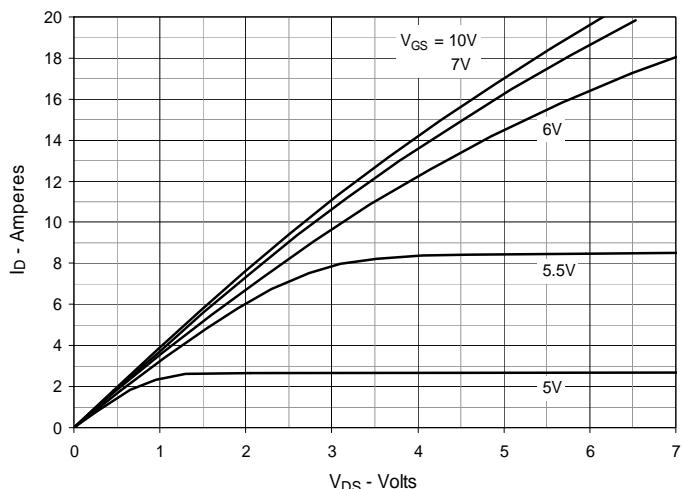
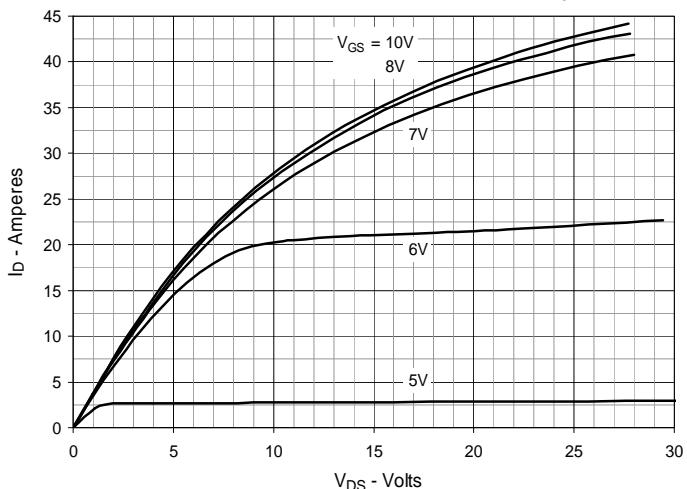
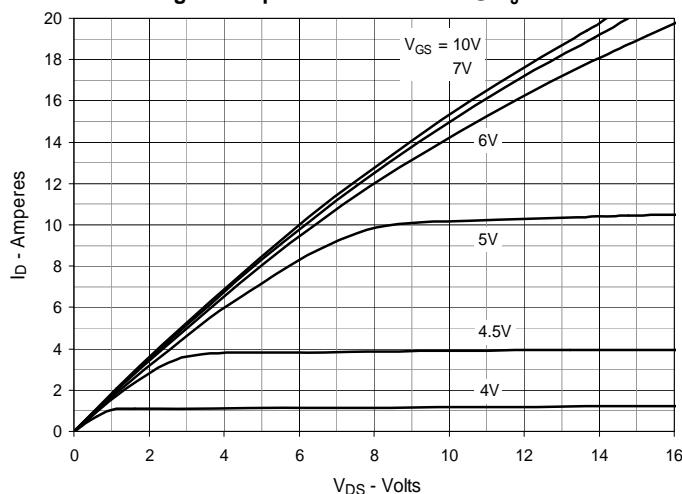
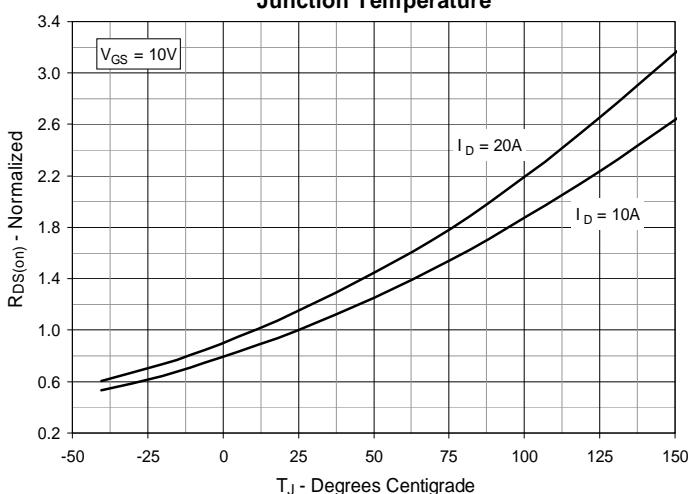
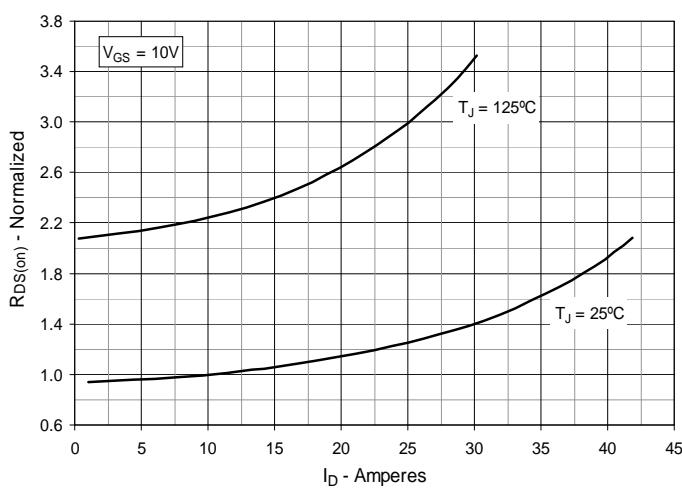
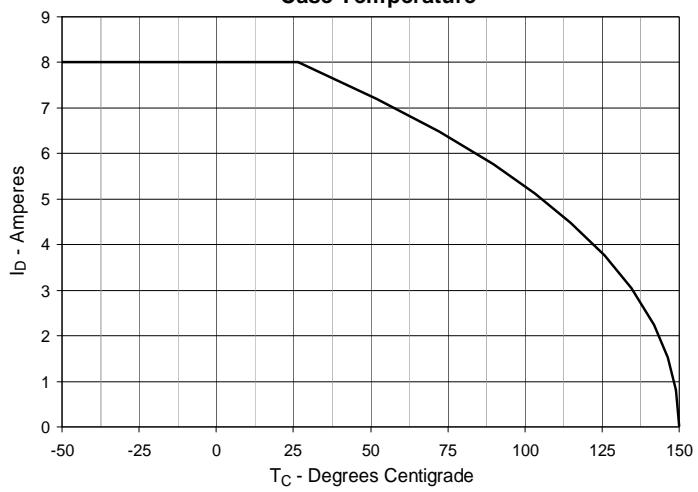
Fig. 1. Output Characteristics @ $T_J = 25^\circ\text{C}$

Fig. 2. Extended Output Characteristics @ $T_J = 25^\circ\text{C}$

Fig. 3. Output Characteristics @ $T_J = 125^\circ\text{C}$

Fig. 4. $R_{DS(on)}$ Normalized to $I_D = 10\text{A}$ Value vs. Junction Temperature

Fig. 5. $R_{DS(on)}$ Normalized to $I_D = 10\text{A}$ Value vs. Drain Current

Fig. 6. Maximum Drain Current vs. Case Temperature


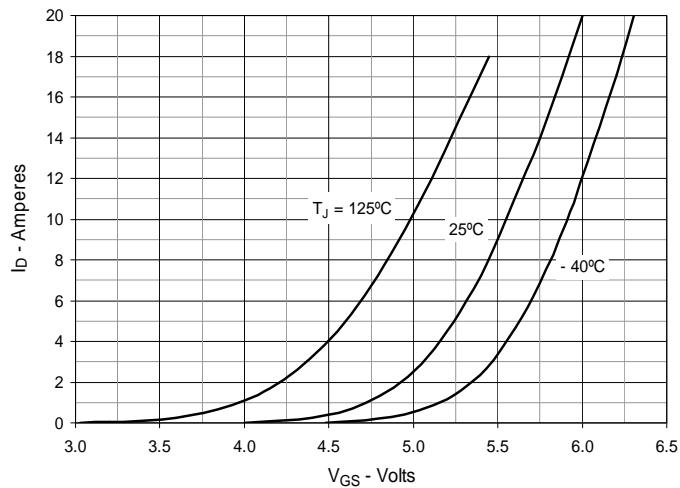
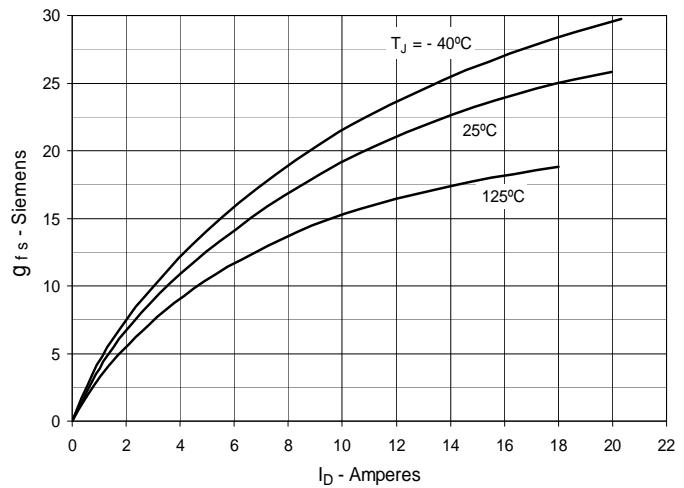
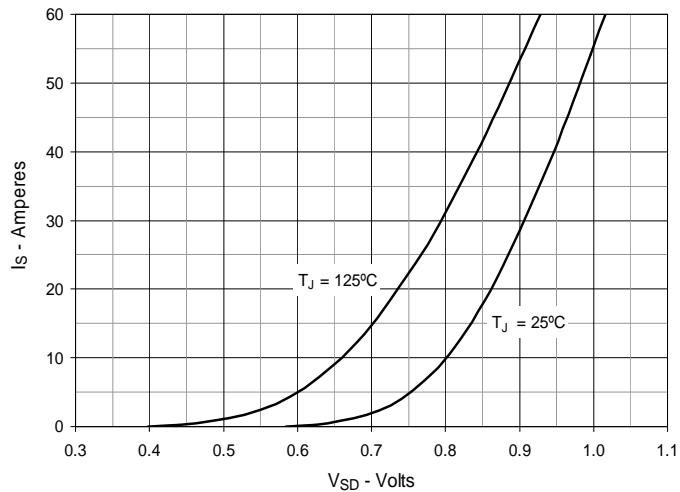
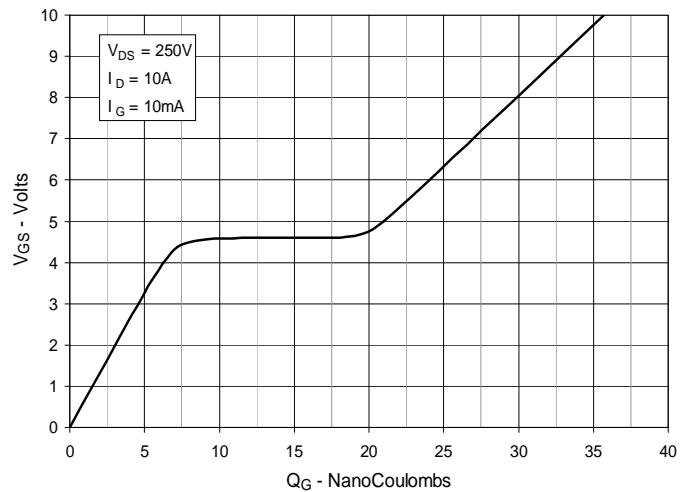
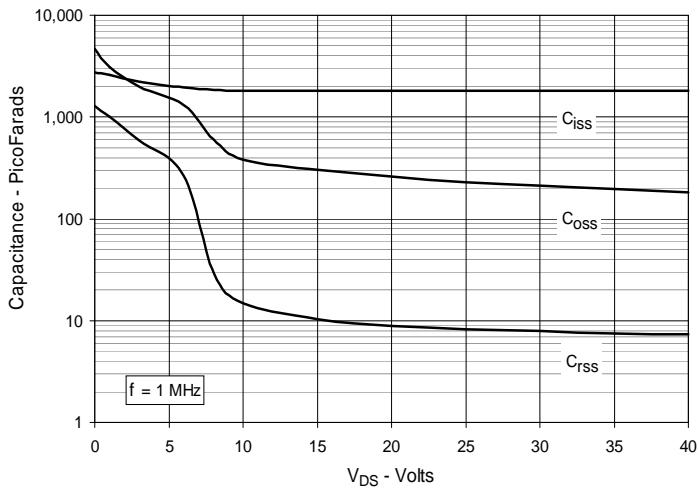
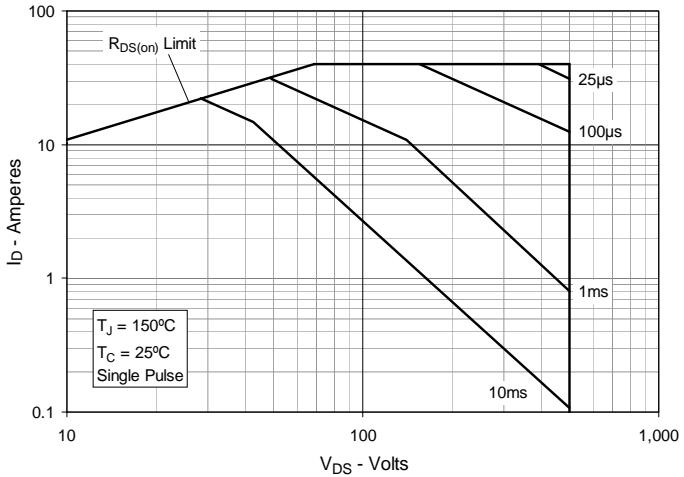
Fig. 7. Input Admittance

Fig. 8. Transconductance

Fig. 9. Forward Voltage Drop of Intrinsic Diode

Fig. 10. Gate Charge

Fig. 11. Capacitance

Fig. 12. Forward-Bias Safe Operating Area


Fig. 13. Maximum Transient Thermal Impedance